

Title (en)

METHOD OF MAKING A COPPER CORE FIVE-PLY COMPOSITE AND COOKING VESSEL

Title (de)

VERFAHREN ZUR HERSTELLUNG EINES FÜNFLAGENVERBANDES MIT KUPFERKERN UND KOCHGESCHIRR

Title (fr)

PROCEDE DE FABRICATION D'UN COMPOSITE EN CINQ COUCHES A NOYAU DE CUIVRE ET RECIPIENT DE CUISSON

Publication

**EP 1094937 B9 20090218 (EN)**

Application

**EP 99921654 A 19990504**

Priority

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- US 8417798 P 19980504

Abstract (en)

[origin: EP1980184A1] A cooking vessel (20) comprises a formed shape made from a composite metal sheet (10) having a copper layer (2) bonded between layers of aluminium (4) and two layers of stainless steel (8) bonded to the aluminium layers (4). The cooking vessel includes at least one skived ring (30) or groove formed around the perimeter of the vessel to visually expose the copper layer (2) and/or a formed upper edge (28) having an end surface which visually exposes the copper layer (2).

IPC 8 full level

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CPC (source: EP KR US)

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